

**IN THE CLAIMS:**

The following listing of claims replaces all prior listings of claims in the present application:

**Listing of Claims:**

1. (Currently amended) A soldering nest provided in a bus bar made entirely of a good electrical and heat-conducting material, the bus bar having an aperture for the introduction of a terminal lead **[(40)]** to be soldered therinto, and the introduction of the terminal lead may be effected from a first surface plane of the bus bar **[(10)]** and soldering may be effected from a second, opposite surface plane of the bus bar **[(10)]**, ~~characterized in that~~ wherein the aperture is formed by a conical bore **[(20)]** which is perpendicular or approximately perpendicular to the surface plane of the bus bar **[(10)]** and whose cone angle is at least 30°; the apex of the conical bore **[(20)]** is oriented toward the first surface plane of the bus bar **[(10)]**, and the conical bore **[(20)]** terminates in a circular aperture **[(21)]** whose diameter is slightly greater than the diameter of the terminal lead **[(40)]**.

2. (Currently amended) The soldering nest as defined in claim 1, ~~characterized in that~~ wherein the cone angle is between 50° and 90°.

3. (Currently amended) The soldering nest as defined in claim 1, ~~characterized in that~~ wherein the terminal lead **[(40)]** is part of a semiconductor device.

4. (New) The soldering nest as defined in claim 1, wherein the bus bar consists of metal.

5. (New) The soldering nest as defined in claim 4, wherein the metal is copper, a copper alloy, or silver.